

Switching Diode DA2J10100L

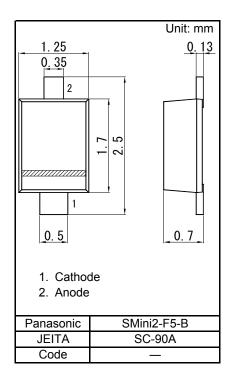
DA2J10100L Silicon epitaxial planar type

For high speed switching circuits

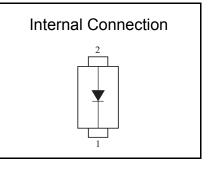
- Features
- Small reverse current IR
- Short reverse recovery time trr
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: A1

Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)



| Parameter | Symbol | Rating | Unit | |
|--|--------|-------------|------|--|
| Reverse voltage | VR | 80 | V | |
| Maximum peak reverse voltage | VRM | 80 | V | |
| Forward current | IF | 100 | mA | |
| Peak forward current | IFM | 225 | mA | |
| Non-repetitive peak forward surge current *1 | IFSM | 500 | mA | |
| Junction temperature | Tj | 150 | °C | |
| Operating ambient temperature | Topr | -40 to +85 | °C | |
| Storage temperature | Tstg | -55 to +150 | °C | |
| Note) *1: t = 1 s | | | | |



■ Absolute Maximum Ratings Ta = 25 °C

Panasonic

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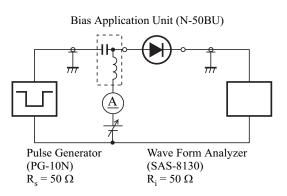
■ Electrical Characteristics Ta = 25 °C ± 3 °C

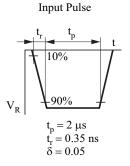
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit | |
|--------------------------|--------|---|-----|------|------|------|--|
| Forward voltage | VF | IF = 100 mA | | 0.92 | 1.20 | V | |
| Reverse voltage | VR | IR = 100 μA | 80 | | | V | |
| Reverse current | IR | VR = 80 V | | | 100 | nA | |
| Terminal capacitance | Ct | VR = 0 V , f = 1 MHz | | | 1.2 | pF | |
| Reverse recovery time *1 | trr | IF = 10 mA, VR = 6 V Irr = 0.25 x IR | | | 3 | ns | |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

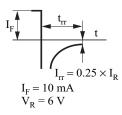
2. Absolute frequency of input and output is 100 MHz.

3. *1: trr test circuit





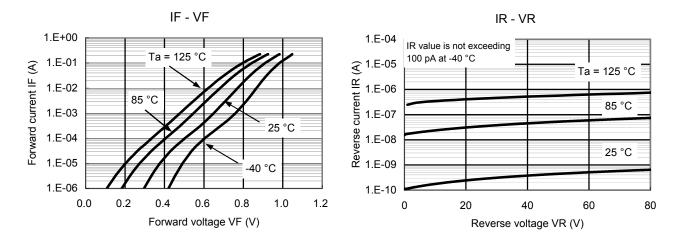


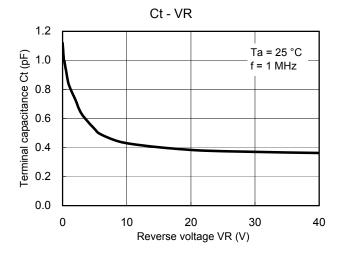




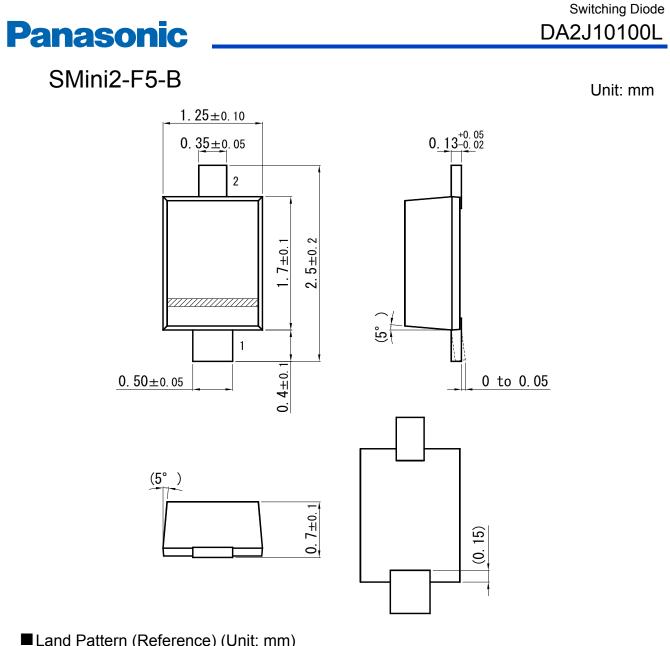
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Technical Data (reference)

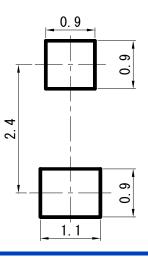




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Land Pattern (Reference) (Unit: mm)



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